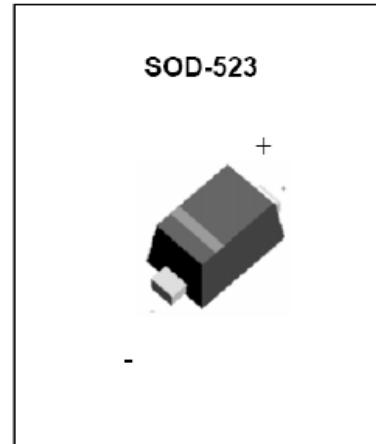




## ESD Protection Diodes

### DESCRIPTION

The CESD12VD5 is designed to protect voltage sensitive components from ESD. Excellent clamping capability, low leakage, and fast response time provide best in class protection on designs that are exposed to ESD. Because of its small size, it is suited for use in cellular phones, MP3 players, digital cameras and many other portable applications where board space is at a premium.



### FEATURES

- Stand-off Voltage: 3.3 V–12 V
- Low Leakage
- Response Time is Typically < 1 ns
- ESD Rating of Class 3 (> 16 kV) per Human Body Model
- IEC61000-4-2 Level 4 ESD Protection
- These are Pb-Free Devices

### Maximum Ratings @ $T_A=25^\circ\text{C}$

Parameter	Symbol	Limits	Unit
IEC61000-4-2(ESD)		$\pm 30$ $\pm 30$	kV
Air			
Contact			
ESD voltage		16	kV
per human body model			
Per machine model		400	V
Total power dissipation on FR-5 board (Note 1)	$P_D$	150	mW
Thermal Resistance Junction-to-Ambient	$R_{\Theta JA}$	833	$^\circ\text{C}/\text{W}$
Lead Solder Temperature – Maximum (10 Second Duration)	$T_L$	260	$^\circ\text{C}$
Junction and Storage temperature range	$T_J, T_{stg}$	-55 ~ +150	$^\circ\text{C}$

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only.

Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. FR-5 = 1.0 x 0.75 x 0.62 in.

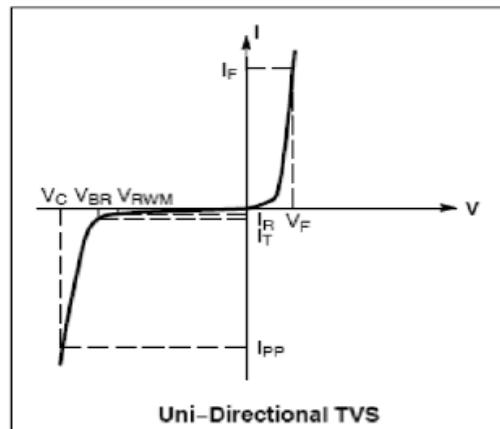


# Taiwan Goodark Technology Co.,Ltd

## CESD12VD5

### ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter
$I_{PP}$	Maximum Reverse Peak Pulse Current
$V_C$	Clamping Voltage @ $I_{PP}$
$V_{RWM}$	Working Peak Reverse Voltage
$I_R$	Maximum Reverse Leakage Current @ $V_{RWM}$
$V_{BR}$	Breakdown Voltage @ $I_T$
$I_T$	Test Current
$I_F$	Forward Current
$V_F$	Forward Voltage @ $I_F$
$P_{pk}$	Peak Power Dissipation
$C$	Max. Capacitance @ $V_R=0$ and $f = 1\text{MHz}$



### ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ unless otherwise noted, $V_F = 0.9\text{ V Max.}$ @ $I_F = 10\text{mA}$ for all types)

Device*	Device Marking	$V_{RWM}$ (V)	$I_R$ ( $\mu\text{A}$ ) @ $V_{RWM}$	$V_{BR}$ (V) @ $I_T$ (Note 2)		$I_T$	$V_C$ @ $I_{PP}^+$ = 5 A	$I_{PP}$ (A) *	$V_C$ (V) @Max $I_{PP}^+$	$P_{pk}^+$ (W)	$C$ (pF)
				Max	Max						
CESD3V3D5	ZE	3.3	0.08	5.0	5.9	1.0	9.4	11.2	14.1	158	105
CESD5V0D6	ZF	5.0	0.08	6.2	7.3	1.0	11.6	9.4	18.6	174	80
CESD7V0D6	ZH	7.0	0.03	7.5	8.7	1.0	13.5	8.8	22.7	200	65
CESD12VD6	ZM	12	0.02	14.1	15.7	1.0	23	9.6	29	240	55

\*Other voltages available upon request.

+Surge current waveform per Figure 1.

2.  $V_{BR}$  is measured with a pulse test current  $I_T$  at an ambient temperature of  $25^\circ\text{C}$ .

### TYPICAL CHARACTERISTICS

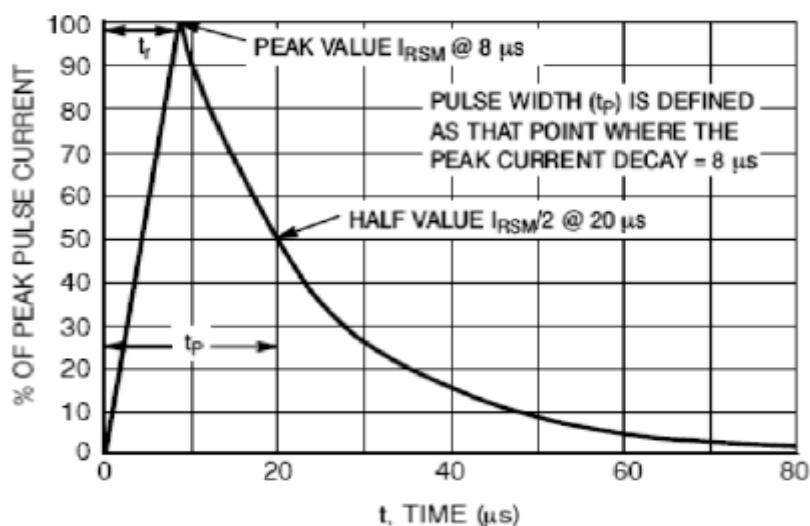


Figure 1.  $8 \times 20\text{ }\mu\text{s}$  Pulse Waveform